TOSHIBA Photocoupler Photo Relay

# **TLP227G, TLP227G-2**

Cordless Telephone

**PBX** 

Modem

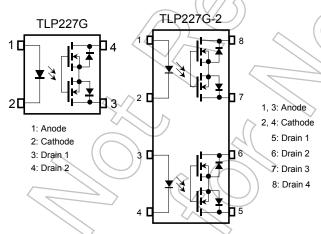
The TOSHIBA TLP227G series consist of an infrared emitting diode optically coupled to a photo-MOS FET in a plastic DIP package.

The TLP227G series are a bi–directional switch which can replace mechanical relays in many applications.

- TLP227G: 4 pin DIP(DIP4), 1 channel type(1 form A)
- TLP227G-2: 8 pin DIP(DIP8), 2 channel type(2 form A)
- Peak off-state voltage: 350 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 120 mA (max)
- On-state resistance: 35 Ω (max)
- Isolation voltage: 2500 Vrms (min)
- Isolation thickness: 0.4mm(min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349
- VDE-approved: EN 60747-5-5 (Note 1)

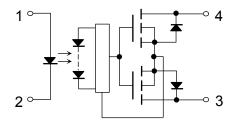
Note 1: When a VDE approved type is needed, please designate the Option(V4).

## Pin Configuration (top view)

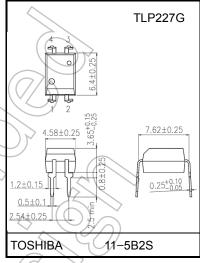


#### **Internal Circuit**

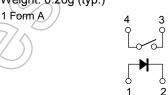
(TLP227G)

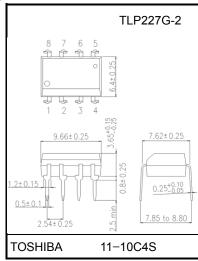


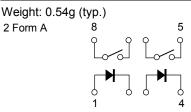
Unit: mm



Weight: 0.26g (typ.)







Start of commercial production 1995-11

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic					Symbol	Rating	Unit
	Forward current	Forward current			lF	50	mA
	Forward current derating (Ta ≥ 25°C)				ΔI <sub>F</sub> / °C	-0.5	mA / °C
	Peak forward current (100µs pulse, 100pps)				IFP	1	Α
LED	Reverse voltage	VR	5	V			
_	Diode power dissipation				PD	50	mW
	Diode power dissipation	derating (Ta ≥ 25	°C)		ΔP <sub>D</sub> /°C	(-0.5)	mW/°C
	Junction temperature				Tj	125	°C
	Off-state output terminal	voltage			Voff	350	V
		TLP227G	227G			120	
	On-state current	TLP227G-2	One channel		ION	120	mA
		TLF22/G-2	Both channel	(Note 1)		100	
		TLP227G				-1.2	
ctor	On-state current derating(Ta ≥ 25°C)	TLP227G-2	One channel		Δlon / °C	-1.2	mA / °C
Detector		TLF 22/ G-2	Both channel	(Note 1)		-1.0	
	Output power dissipation		TLP227G		/ )) <sub>D</sub>	432)	
			TLP227G-2		Po	600	)) mW
	Output power dissipation derating (Ta ≥ 25°C)		TLP227G	20	> ΔPo/°C	-4.32	
			TLP227G-2	TLP227G-2		-6.0	mW / °C
	Junction temperature				Tj 🕢	125	°C
Storage temperature range				Tstg	_55 to 125	°C	
Оре	Operating temperature range				Topr	-40 to 85	°C
Lea	Lead soldering temperature (10 s)				T <sub>sol</sub>	260	°C
Isol	Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 2)				BVs	2500	V <sub>rms</sub>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1): Two channels operating simultaneously.

(Note 2): Device considered a two-terminal device: LED side pins shorted together, and detector side pins shorted together.

### **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	$V_{DD}$	_	-	280	V
Forward current	lF	5	7.5	25	mA
On-state current	Ion	_	_	100	mA
Operating temperature	T <sub>opr</sub>	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

# Individual Electrical Characteristics (Ta = $25^{\circ}$ C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μΑ
	Capacitance	Ст	VF = 0 V, f = 1 MHz	/	30	-	pF
tor	Off-state current	loff	V <sub>OFF</sub> = 350 V		/2	1	μΑ
Detector	Capacitance	Coff	V = 0 V, f = 1 MHz		40	1	pF

## **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Trigger LED current	I <sub>FT</sub>	I <sub>ON</sub> = 120 mA	- (2	2	3	mA
On-state resistance	R <sub>ON</sub>	I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA	+(	))22	35	Ω
OII-state resistance		ION = 20 to 120 mA, I <sub>F</sub> = 5 mA	H	26//	40	22
Return LED current	IFC	I <sub>OFF</sub> = 100 μA	0. 0.	)		mA

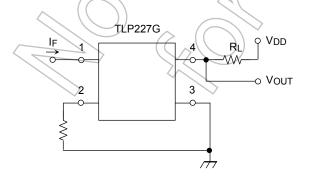
# Isolation Characteristics (Ta = 25°C)

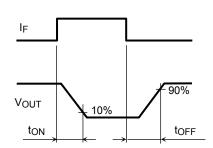
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	Vs = 0 V, f = 1MHz	_	0.8	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5×10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	BVs	AC, 60 s	2500	-	_	V <sub>rms</sub>

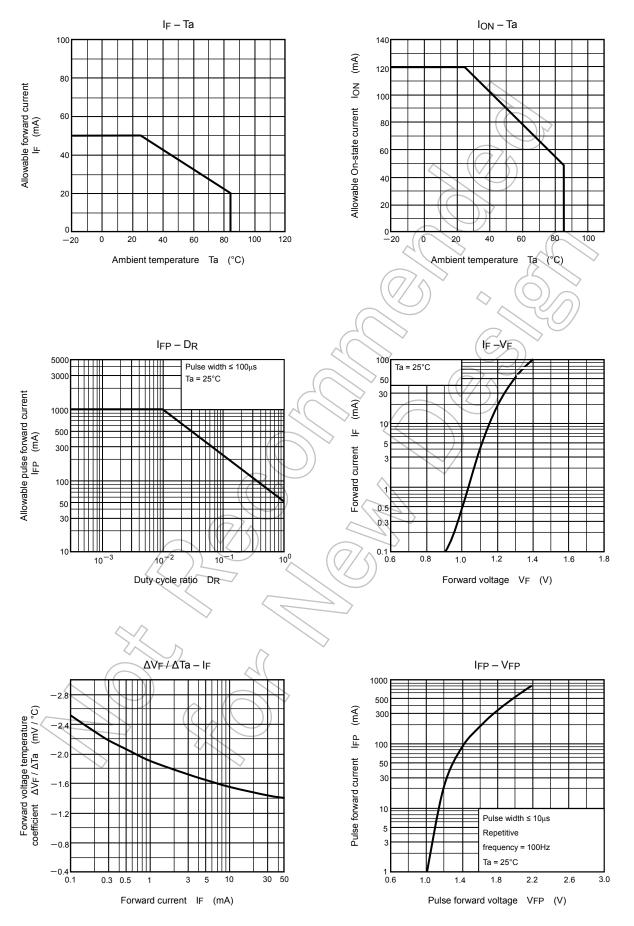
# Switching Characteristics (Ta = 25°C)

Characteristic	Symbol Test Condition	Min	Тур.	Max	Unit
Turn-on time	$t_{ON}$ $R_L = 200 \Omega$	_	0.3	1	mo
Turn-off time	$t_{OFF}$ $V_{DD} = 20 \text{ V}, I_F = 5 \text{ mA (Note 3)}$	_	0.1	1	ms

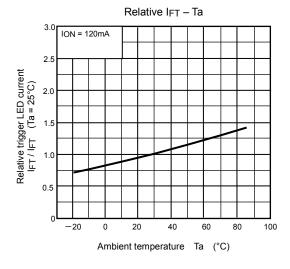
(Note 3): Switching Time Test Circuit

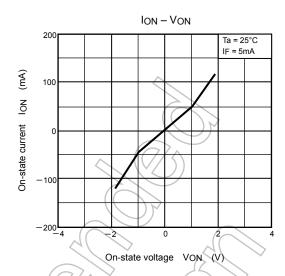


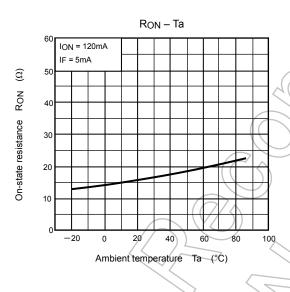


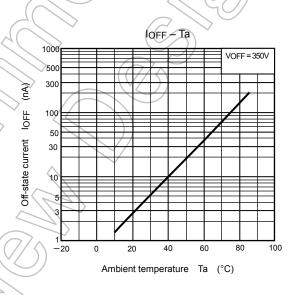


NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.









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